RENESAS

RH850 Evaluation Platform

RH850/F1x 48pin RH850/F1Kx 48pin

PiggyBack board V1

Y-RH850-F1X-048PIN-PB-T1-V1

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- Handling of Unused Pins Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.
 - The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.
- 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

 The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

 Prohibition of Access to Reserved Addresses Access to reserved addresses is prohibited.

Access to reserved addresses is prohibited

The reserved addresses are provided for the possible future expansion of functions. Do not access
these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has **s**tabilized.

 When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.



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Chapter 1 Introduction

The RH850/F1x Application Board is part of the RH850 Evaluation Platform and serves as a simple and easy to use platform for evaluating the features and performance of Renesas Electronics 32-bit RH850/F1x microcontrollers. The piggyback board (Y-RH850-F1X-048PIN-PB-T1-V1) can be used as a standalone board, or can be mated with a mainboard (e.g. Y-RH850-X1X-MB-Tx-Vx) for extended functionality.

Main features:

- Socket for mounting of device
- Standalone operation of the board
- Direct supply of device voltage (typ. 3.3V-5.0V)
- Device programming capability
- Device debugging capability
- Pin headers for direct access to each device pin
- Reset switch
- MainOSC circuitry
- Connectors to MainBoard

This document describes the functionality provided by the piggyback board and guides the user through its operation.



Chapter 2 Overview

2.1 Overview

Figures 1 and 2 provide the views of the Piggyback Board.



Figure 1 – PiggyBoard top view



Figure 2 – PiggyBoard bottom view



2.2 Mounting of the device

The board is designed for use with the following device:

- RH850/F1L 48pin
- RH850/F1KM-S1 48pin

The device must be placed inside the socket IC1. To insert the device, press down the lid, align the #1 pin of the device to the #1pin of the socket, insert the device inside the socket and release the lid.

For details regarding the operation of the microcontrollers, refer to the RH850/F1L or RH850/F1KM User's Manual.



Chapter 3 Power supply

3.1 Board power connections

For operation of the device, a supply voltage must be connected to the board. Though a single supply voltage is sufficient for the operation of the device, two (different) voltages can be supplied to the board.

Within this document the following voltages are considered as 'typical' connections:

Voltage1 = 5.0V

Voltage2 = 3.3V

The following connectors are available to supply those voltages:

- Three 4mm 'banana-type' connectors:
 - Two red connectors for voltages *Voltage1* (CN10) and *Voltage2* (CN11).
 A black connector for VSS connection (CN12).
 - Note: The three connectors are supplied with the board but not assembled.
- The E1 emulator that is used for debug purposes and flash programming can also supply a single operating voltage ('Dbg_Voltage'). The voltage is programmable via the E1 GUI as 3.3 or 5.0V (typ). See the documentation of the E1 and chapter 5 'Debug and Programming interface' for details.
- In case the PiggyBoard is mounted on a MainBoard, the voltages *Voltage1* and *Voltage2* are supplied by the on-board regulators of the MainBoard.

NOTE: Do not supply any voltage directly to the PiggyBoard in case it is mounted on the MainBoard.

For each of the two voltages, 'Voltage 1 ' and 'Voltage 2', a green LED (LED1 and LED2) is available to signal that the related voltage is available on the PiggyBoard.



3.2 Voltage distribution

Device supply pin	Function
REGVCC	Supply for the device internal regulators for the digital logic.
EVCC	Supply for ports of AWO and ISO area.
A0VREF	Supply for ports and analog functions of ADC0.

The table shows the required device power supply pins and their function:

Additionally one power supply for MainBoard can be selected:

Supply voltage	Function
VDDIOF	IO supply voltage for components located on a connected mainboard.

• For each of the above voltages, the voltage source can be selected from *Voltage1* (typ. 5.0V) or *Voltage2* (typ. 3.3V) by the jumpers JP1, JP2, JP4, JP6, respectively the jumpers JP0 and JP9.





Chapter 4 Clock sources

4.1.1 MainOsc

A crystal or ceramic resonator in the range of 8MHz to 24MHz can be mounted on socket X1.

A 8MHz and 16Mhz oscillator is supplied with the board.



Chapter 5 Debug and Programming interface

For connection of the microcontroller debug and flash programming tools, the connector CN19 is provided.

CN19 pin	Device Port	Device signal	
1	JP0_2	DCUTCK / LPDCLK	
2	GND	GND	
3	JP0_4	DCUTRST	
4	FLMD0	FLMD0	
5	JP0_1	DCUTDO / LPDO	
6	P10_8*	FLMD1	
7	JP0_0	DCUTDI / LPDI	
8	'Dbg_Voltage'	-	
9	JP0_3	DCUTMS	
10	-	-	
11	JP0_5	DCURDY / LPDCLKOUT	
12	GND	-	
13	RESET	-	
14	GND	-	

The signal connection of the connector CN19 is shown in the picture below:

* In case the FLMD1 signal must be controlled by the debug/programming tool, the pin header JP11 must be closed.

The 'Dbg_Voltage' (on CN19 pin 8) is monitored or supplied by the debug and flash programming tools. Therefore, it is necessary to select either Voltage1 (5V) or the Voltage2 (3.3V) by pin header JP10:

JP10 pin	Selection for Dbg_Voltage					
1-2	5V is selected					
2-3	3.3V is selected					



Chapter 6 Connectors for ports of device

Connection to each pin of the device is possible via the connectors CN5 to CN8.

Note :The pin headers are directly connected to the pins, therefore special care must be taken to avoid any electrostatic or other damage to the device.

6.1 Push button for RESET

In order to issue a RESET to the device, the push-button SW1 is available.

6.2 Connectors to MainBoard

Three connectors (CN1 to CN3) are available to connect the PiggyBoard to a MainBoard.

The signal connection of each connector is described in the following tables:

6.2.1 Connector CN1

Pin	Function	Device Port	Pin	Function	Device Port
1	VDDA	-	2	VDDA	-
3	VDDA	-	4	VDDA	-
5	RESET	_RESET	6	NMI	P9_0
7	WAKE	-	8	-	-
9	INT0	P9_1	10	INT1	-
11	-	-	12	INT3	-
13	-	-	14	-	-
15	UART0TX	P10_10	16	-	-
17	UART0RX	P10_9	18	-	-
19	LIN0TX	P10_10	20	LIN1TX	P0_1
21	LINORX	P10_9	22	LIN1RX	P0_0
23	IIC0SDL	P10_3	24	IIC1SDL	-
25	IIC0SDA	P10_2	26	IIC1SDA	-
27	CAN0TX	P10_1	28	CAN1TX	-
29	CANORX	P10_0	30	CAN1RX	-
31	SENTIN0	-	32	SENTIN1	-
33	SENTOUT0	-	34	SENTOUT1	-
35	PSI50Rx	-	36	PSI51Rx	-
37	PSI50Tx	-	38	PSI51Tx	-
39	PSI50Snyc	-	40	PSI51Sync	-
41	FLX0TX	-	42	FLX0EN	-
43	FLX0RX	-	44	-	-



45	FLX1TX	-
47	FLX1RX	-
49	-	-
51	ETH0MDIO	-
53	ETH0RXD0	-
55	ETH0RXD1	-
57	ETH0RXD2	-
59	ETH0RXD3	-
61	ETH0RXDCLK	-
63	ETH0RXER	-
65	ETH0CRSDV	-
67	ETHORXDV	-
69	ETH0RESET	-
71	-	-
73	USB0UDMF	-
75	USB0UDPF	-
77	-	-
79	-	-
81	-	-
83	-	-
85	DIGIO_0	P8_0
87	-	-
89	-	-
91	-	-
93	DIGIO_8	P10_0
95	DIGIO_10	P10_8
97	-	-
99	-	-
101	-	-
103	MUX0	P10_4
105	MUX2	P10_6
107	ADC0	AP0_0
109	ADC2	AP0_2
111	ADC4	AP0_4
113	ADC6	AP0_6
115	VDDIOF	-
117	VDDB	-
119	VDDB	-

46	FLX1EN	-
48	-	-
50	-	-
52	ETH0MDC	-
54	EH0TXD0	-
56	EH0TXD1	-
58	EH0TXD2	-
60	EH0TXD3	-
62	ETH0TXCLK	-
64	ETH0TXER	-
66	ETH0TXEN	-
68	ETH0COL	-
70	-	-
72	-	-
74	USB0UDMH	-
76	USB0UDPH	-
78	-	-
80	-	-
82	-	-
84	-	-
86	DIGIO_1	P8_1
88	-	-
90	-	-
92	DIGIO_7	P0_0
94	DIGIO_9	P10_7
96	-	-
98	-	-
100	-	-
102	-	-
104	MUX1	P10_5
106	-	-
108	ADC1	AP0_1
110	ADC3	AP0_3
112	ADC5	AP0_5
114	ADC7	AP0_7
116	VDDIOF	-
118	VDDB	-
120	VDDB	-

6.2.2 Connector CN2

Pin	Function	Device Port	Pin	Function	Device Port
1	CAN2Tx	-	2	CAN3Tx	-
3	CAN2Rx	-	4	CAN3Rx	-
5	CAN4Tx	-	6	CAN5Tx	-
7	CAN4Rx	-	8	CAN5Rx	-
9	LIN2Tx	P10_5	10	LIN3Tx	-
11	LIN2Rx	P10_4	12	LIN3Rx	-
13	LIN4Tx	-	14	LIN5Tx	-
15	LIN4Rx	-	16	LIN5Rx	-
17	LIN6Tx	-	18	LIN7Tx	-
Q	LIN6Rx	-	20	LIN7Rx	-
21	LIN8Tx	-	22	LIN9Tx	-
23	LIN8Rx	-	24	LIN9Rx	-
25	LIN10Tx	P10_10	26	LIN11Tx	-
27	LIN10Rx	P10_9	28	LIN11Rx	-
29	LIN12Tx	-	30	LIN13Tx	-
31	LIN12Rx	-	32	LIN13Rx	-
33	LIN14Tx	-	34	LIN15Tx	-
35	LIN14Rx	-	36	LIN15Rx	-
37	-	-	38	-	-
39	-	-	40	-	-
41	MLBCLK	-	42	MLBRESET	-
43	MLBSIG	-	44	MLBDAT	-
45	-	-	46	-	-
47	-	-	48	-	-
49	-	-	50	-	-
51	-	-	52	-	-
53	-	-	54	-	-
55	-	-	56	-	-
57	-	-	58	-	-
59	-	-	60	-	-
61	-	-	62	-	-
63	-	-	64	-	-
65	-	-	66	-	-
67	-	-	68	-	-
69	-	-	70	-	-
71	-	-	72	-	-
73	-	-	74	-	-
75	-	-	76	-	-
77	-	-	78	-	-
79	-	-	80	-	-

81	-	-	82	-	-
83	-	-	84	-	-
85	-	-	86	-	-
87	-	-	88	-	-
89	-	-	90	-	-
91	-	-	92	-	-
93	-	-	94	-	-
95	-	-	96	-	-
97	-	-	98	-	-
99	-	-	100	-	-
101	-	-	102	-	-
103	-	-	104	-	-
105	-	-	106	-	-
107	-	-	108	-	-
109	-	-	110	-	-
111	-	-	112	-	-
113	-	-	114	-	-
115	-	-	116	-	-
117	-	-	118	-	-
119	-	-	120	-	-

6.2.3 Connector CN3

Pin	Function	Device Port	Pi	in	Function	Device Port
1	PWM00	P10_0	2		PWM01	P10_1
3	PWM02	P10_2	4		PWM03	P10_3
5	PWM04	P10_7	6		PWM05	P10_8
7	PWM06	P10_9	8		PWM07	P10_10
9	PWM08	P9_0	10)	PWM09	P9_1
11	PWM10	P0_0	12		PWM11	P0_1
13	PWM12	P0_2	14		PWM13	-
15	PWM14	-	16	;	PWM15	-
17	PWM16	-	18		PWM17	-
Q	PWM18	-	20)	PWM19	-
21	PWM20	-	22		PWM21	-
23	PWM22	-	24		PWM23	-
25	PWM24	-	26	;	PWM25	-
27	PWM26	-	28		PWM27	-
29	PWM28	-	30)	PWM29	-
31	PWM30	-	32		PWM31	-
33	PWM32	-	34		PWM33	-
35	PWM34		36	;	PWM35	



07	D144400		00	DIAMAGE	
37	PWM36	-	38	PWM37	-
39	PWM38	-	40	PWM39	-
41	PWM40	-	42	PWM41	-
43	PWM42	-	44	PWM43	-
45	PWM44	-	46	PWM45	-
47	PWM46	-	48	PWM47	-
49	PWM48	-	50	PWM49	-
51	PWM50	-	52	PWM51	-
53	PWM52	-	54	PWM53	-
55	PWM54	-	56	PWM55	-
57	PWM56	-	58	PWM57	-
59	PWM58	-	60	PWM59	-
61	PWM60	-	62	PWM61	-
63	PWM62	-	64	PWM63	-
65	PWM64	-	66	PWM65	-
67	PWM66	-	68	PWM67	-
69	PWM68	-	70	PWM69	-
71	PWM70	-	72	PWM71	-
73	PWM72	-	74	PWM73	-
75	PWM74	-	76	PWM75	-
77	PWM76	-	78	PWM77	-
79	PWM78	-	80	PWM79	-
81	PWMADC00	-	82	PWMADC01	-
83	PWMADC02	-	84	PWMADC03	-
85	PWMADC04	-	86	PWMADC05	-
87	PWMADC06	-	88	PWMADC07	-
89	PWMADC08	_	90	PWMADC09	-
91	PWMADC10	-	92	PWMADC11	-
93	PWMADC12	-	94	PWMADC13	-
95	PWMADC14	-	96	PWMADC15	-
97	-	_	98	-	-
99	-	-	100	-	-
101	-	_	102	-	-
103	-	-	104	-	-
105	-	-	106	-	-
107	_	_	108	-	-
109	-	_	110	-	-
111	_	_	112	_	_
113	-	-	114	-	-
115	-	-	116	-	-
117	-	-	118	-	-
119	-	_	120	-	_
113			120		1

Chapter 7 Mechanical dimensions











Chapter 9 Revision History

The table provides information about the major changes of the document versions.

Date	Version	Description
2014-05-21	1.0	Initial release
2014-05-28	1.1	Updated cover page
2015-10-21	1.2	Updated schematic for better readability (same content) Updated table for CN1 and CN2 (chapter 6.2) Updated table for CN19 pin6, chapter 5
2018-11-23	1.30	Added reference to F1KM-S1 device

